

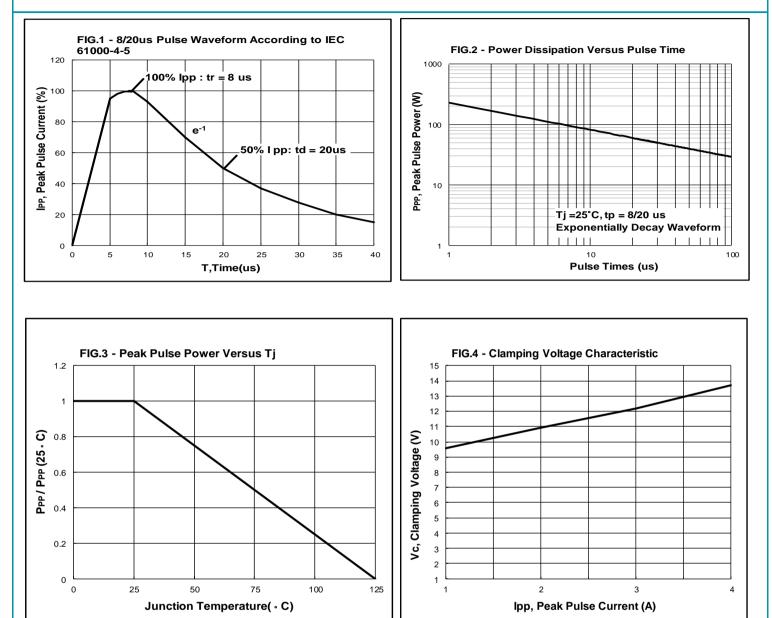
### H04X645V0U

ESD Array Protection Device			Peak Pulse   Reverse Wo				
Description		Mechanical Data					
The H04X645V0U is ultra low capacitance ESD arrays designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from over voltage caused by ESD (electrostatic discharge).		Case: DFN2510 Package     Case: Material: "Crean" Melding Compound LIL Flormshillity					
		• Case Material: "Green" Molding Compound UL Flammability					
		Classification Rating 94V-0					
		Terminal: Matte tin plated.					
Features		Component in accordance to RoHS					
<ul> <li>Protects four I/O lines (Data line)</li> </ul>		● Halogen Free					
• Peak Pulse Power :Ppp = 60W (tp=8/20 us)		Note: Products with logo					
Reverse Working Voltage : 5V		are made by HY Electronic (Cayman) Limited.					
Low Leakage Current	Ordering Information						
■ Ultra Low Junction Capacitance : I/O to I/O , 0.3pF (Max)		Package :D					
■ IEC 61000-4-2 (ESD) :±20kV(Contact) / ±25kV(Air)		Reel Size :					
■ IEC 61000-4-4 (EFT) 40A (5/50ns)		-	er Reel :3,000/Ta	-			
		•	ne Box :30,000/T	-			
Applications		-	ne Carton :120,00	00/Tape 8	Reel		
<ul> <li>High definition multi-media interface (HDMI)</li> </ul>	M	larking l	nformation				
<ul> <li>Digital visual interface (DVI)</li> </ul>					٦		
<ul> <li>Display protTM interface</li> </ul>			052	74P			
		• 0524P					
● USB3.0(5G) / USB 3.1(10G)			Ţ				
MDDI ports / SATA	Å Å	Пп	Product Type atic & PIN C		<b>ration</b> Pin Assign 1, 2, 4, 5	ment Input lines NC	-
DFN2510 Top View	Pin4 P n3.8		atic & PIN C		<b>ration</b> Pin Assigni 1, 2, 4, 5	Input lines	
<ul> <li>MDDI ports / SATA</li> <li>Package Outline</li> <li>Image: print prin</li></ul>	Pin4 P n3.8		atic & PIN C		<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10	Input lines NC	
<ul> <li>MDDI ports / SATA</li> <li>Package Outline</li> <li>Pin1 Pin2</li> <li>Pin1 Pin2</li> <li>Pin2 Pin2</li> <li>Pin1 Pin2</li> <li>Pin2 Pin2</li> <li>Pin3 Pin2</li> <li>Pin4 Pin2</li> <li>Pin4 Pin2</li> <li>Pin5 Pin5</li> </ul>	Pin4 P n3.8 specified.)		atic & PIN C		<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10	Input lines NC	-
<ul> <li>MDDI ports / SATA</li> <li>Package Outline</li> <li>Find Pind</li> <li>Find Pind</li></ul>	Pin4 P n3.8 specified.)	Pin5	atic & PIN C	Configu	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10	Input lines NC	Un W
<ul> <li>MDDI ports / SATA</li> <li>Package Outline</li> <li>Image: pint print print</li></ul>	Pin4 P n3.8 specified.)	Pin5	atic & PIN C	Configu	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10	Input lines NC	Un W
<ul> <li>MDDI ports / SATA</li> <li>Package Outline         <ul> <li>Pin1</li> <li>Pin2</li> <li>Pin1</li> <li>Pin2</li> <li>Pin2<td>Pin4 P Pin4 P specified.)</td><td>Pin5</td><td>atic &amp; PIN C</td><td>Configu</td><td><b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10</td><td>Input lines NC</td><td>Un \\\ A</td></li></ul></li></ul>	Pin4 P Pin4 P specified.)	Pin5	atic & PIN C	Configu	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10	Input lines NC	Un \\\ A
MDDI ports / SATA Package Outline Uperator of the second s	Pin4 P Pin4 P specified.)	Pin5	atic & PIN C	<b>Value</b> 60 4 ±20 ±25	ration Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8	Input lines NC	Un \\\ A
MDDI ports / SATA Package Outline Uperating Outline Uperating (@TA = +25°C, unless otherwise set absolute Ratings Parameter Peak Pulse Power Dissipation (8/20 us) Peak Pulse Current (8/20 us) SD Protection- Contact (Standard IEC 61000-4-2) ESD Protection- Air (Standard IEC 61000-4-2) Depreating Temperature Range	Pin4 P n3.8 specified.)	Pin5 Pin5	atic & PIN C	<b>Value</b> 60 4 ±20 ±25 55 to +12	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10 3, 8 5	Input lines NC	Un W A k <sup>1</sup>
<ul> <li>MDDI ports / SATA</li> <li>Package Outline         <ul> <li>Find print</li> <li>Pind prind</li> <li>Pind prind</li> <li>Pind</li></ul></li></ul>	Pin4 P n3.8 specified.)	Pin5 Pin5	atic & PIN C	<b>Value</b> 60 4 ±20 ±25 55 to +12 55 to +15	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10 3, 8 5	Input lines NC	Un W A
<ul> <li>MDDI ports / SATA</li> <li>Package Outline         <ul> <li></li></ul></li></ul>	Pin4 P n3.8 specified.)	Pin5 Pin5	atic & PIN C	<b>Value</b> 60 4 ±20 ±25 55 to +12	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10 3, 8 5	Input lines NC	Un W A k <sup>1</sup>
MDDI ports / SATA Package Outline  DFN2510 Top View  Maximum Ratings (@TA = +25°C, unless otherwise s Absolute Ratings Parameter Peak Pulse Power Dissipation (8/20 us) Peak Pulse Current (8/20 us) SD Protection- Contact (Standard IEC 61000-4-2) SD Protection- Air (Standard IEC 61000-4-	Pin4 P n3.8 specified.)	Pin5 PPP PPP PPP PPP PPP TJ TJ TSTG TL I	atic & PIN C	<b>Value</b> 60 4 ±20 ±25 55 to +12 55 to +15 260	<b>ration</b> Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8 5 0	Input lines NC Ground	
MDDI ports / SATA Package Outline  U Pin1 Pin2 Pin2 Pin Pin2 Pin2 Pin2 Pin2 Pin2	Pin4 P Pin4 P n3.8 specified.)	Pin5 Pin5	atic & PIN C	<b>Value</b> 60 4 ±20 ±25 55 to +12 55 to +15	<b>ration</b> Pin Assigni 1, 2, 4, 5 6, 7, 9, 10 3, 8 5	Input lines NC Ground	Un M A k <sup>1</sup> 0 0 Un
MDDI ports / SATA Package Outline  DFN2510 Top View  Pin1 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2	Pin4 P Pin4 P A n3.8 specified.) Sy C Test C Any I/O	Pin5 Pombol PPP IPP VESD TJ TSTG TL Conditions pin to grou	atic & PIN C	Configu	<b>ration</b> Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8 5 0	Input lines NC Ground	Un W A k <sup>1</sup> 0 0 0 0 0 0
MDDI ports / SATA Package Outline  DFN2510 Top View  Pin1 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2 Pin2	Pin4 P Pin4 P Specified.) Sy Sy Specified.)	Pin5 A gymbol PPP IPP VESD TJ TSTG TL Conditions pin to grou r= 1mA	atic & PIN C	<b>Value</b> 1 1 1 1 1 1 1 1 1 1 1 1 1	<b>ration</b> Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8 5 0	Input lines NC Ground	Un Vn k <sup>1</sup> · · · · · · · · ·
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<ul> <li>MDDI ports / SATA</li> <li>Package Outline</li> <li>DFN2510 Top View</li> <li>Maximum Ratings (@TA = +25°C, unless otherwise stabsolute Ratings</li> <li>Parameter</li> <li>Peak Pulse Power Dissipation (8/20 us)</li> <li>Peak Pulse Current (8/20 us)</li> <li>SD Protection- Contact (Standard IEC 61000-4-2)</li> <li>SD Protection- Air (Standard IEC</li></ul>	Pin4 P Pin4 P Pin4 P System	Pin5 A gymbol PPP IPP VESD TJ TSTG TL Conditions pin to grou r= 1mA	atic & PIN C	Configu	<b>ration</b> Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8 5 0	Input lines NC Ground	Un Vn A k <sup>1</sup> · · · · · · · ·
<ul> <li>MDDI ports / SATA</li> <li>Package Outline         <ul> <li></li></ul></li></ul>	Pin4 P Pin4 P n3.8 specified.) Sy Test C Any I/O IT VV IPP = 1 IPP = 4 VR = 0 <sup>1</sup>	Pin5 Pin5	atic & PIN C	Configu	ration         Pin Assign         1, 2, 4, 5         6, 7, 9, 10         3, 8         5         0 <b>Typ</b> -         -	Input lines NC Ground	Un W A K V Un
MDDI ports / SATA Package Outline Upin1 Pin2 Pin1 Pin2 Pin1 Pin2 Pin2 Pin Maximum Ratings (@TA = +25°C, unless otherwise s Absolute Ratings Parameter Peak Pulse Power Dissipation (8/20 us) Peak Pulse Current (8/20 us) SD Protection- Contact (Standard IEC 61000-4-2) SD Protection- Air (	Pin4 P Pin4 P n3.8 specified.) Sy Sy Sy Sy Sy Sy Sy Sy Sy Sy Sy Sy Sy	Pin5 Pin5	atic & PIN C	Configu	<b>ration</b> Pin Assign 1, 2, 4, 5 6, 7, 9, 10 3, 8 5 0	Input lines NC Ground	Un W A A V Un V V V V

Rev-2, 20-Jul-2021

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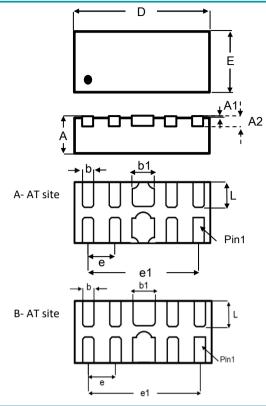
#### **Rating and Characteristic Curves**





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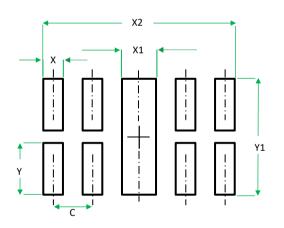
#### **Package Outline Dimensions**



DFN2510 Package						
Dim.	Min	Тур	Max			
D	2.45	2.50	2.55			
E	0.95	1.00	1.05			
А	0.45	0.50	0.55			
A1	0.00	-	0.05			
A2	0.15REF					
b	0.15	0.20	0.25			
b1	0.35	0.40	0.45			
е	-	0.50	-			
e1	-	2.00	-			
L	0.33	0.38	0.43			
All Dimensions in mm						

Note: HY internal have both AT site

### Suggested Soldering Pad Layout



Dim.	Value			
Х	0.25			
X1	0.45			
X2	2.25			
Y	0.63			
Y1	1.40			
С	0.50			
All Dimensions in mm				

### **Legal Disclaimer Notice**

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